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**Connector, MTA 156, Card Edge**

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**1. SCOPE**

## 1.1. Content

This specification covers the performance requirements for the AMP\* MTA 156 card edge connector system. This system provides a reliable interconnection between wires and printed circuit boards.

## 1.2. Qualification

When tests are performed on the subject product line, procedures specified in Figure 1 shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

**2. APPLICABLE DOCUMENTS**

The following AMP documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

- A. 109-1: General Requirements for Test Specifications
- B. 109 Series: Test Specifications as indicated in Figure 1
- C. 114-1020: Connector MTA 156, Application of

**3. REQUIREMENTS**

## 3.1. Design and Construction

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

## 3.2. Materials

- A. Contact: Phosphor bronze, post tin plated
- B. Housing: Thermoplastic polyester 94V-0

## 3.3. Ratings

- A. Current/Voltage: 600 vac at 5 amperes maximum

**NOTE** *The maximum rated current that can be carried by this product is limited by the maximum operating temperature of the housings (105 °C) and the temperature rise of the contacts (30 °C). Variables which shall be considered for each application are: wire size, contact material, ambient temperature, and printed circuit board.*

- B. Operating Temperature: -55 to 105 °C

## 3.4. Performance and Test Description

Product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1.

## 3.5. Test Requirements and Procedures Summary

Test Description	Requirement			Procedure
Examination of product.	Meets requirements of product drawing and AMP Spec 114-1020.			Visual, dimensional and functional per applicable inspection plan.
ELECTRICAL				
Termination resistance, dry circuit.	4.0 milliohms maximum initial.			AMP Spec 109-6-1, Condition A. Subject mated connectors assembled in housing to 50 mv open circuit at 100 ma maximum. See Figure 3.
Termination resistance, specified current.	Wire Size (AWG)	Specified Current (amperes)	Milliohms Maximum (initial)	AMP Spec 109-25. Measure potential drop of mated contacts assembled in housing. Calculate resistance. See Figure 3.
	26	1.0	5.0	
	24	1.0	5.0	
	22	1.5	4.0	
	20	2.0	4.0	
	18	3.0	4.0	
Insulation resistance.	5000 megohms minimum initial. 1000 megohms minimum final.			AMP Spec 109-28-4. Test between adjacent contacts of unmated connector assemblies.
Dielectric withstanding voltage.	1.25 kvac at sea level. 1 minute hold with no breakdown or flashover.			AMP Spec 109-29-1. Test between adjacent contacts of unmated connector assemblies.
Temperature rise vs current.	See Figure 4.			AMP Spec 109-45-2. Temperature rise at rated current.
MECHANICAL				
Tensile, straight.	Wire Size (AWG)	Slot Tensile (Lb minimum)		AMP Spec 109-16. Determine slot tensile at a rate of 1 inch per minute. Apply force parallel to axis of wire.
	26	5.0		
	24	8.0		
	22	12.0		
	20	17.0		
	18	30.0		
Tensile, perpendicular.	Wire Size (AWG)	Slot Tensile (Lb minimum)		AMP Spec 109-16. Determine slot tensile at a rate of 1 inch per minute. Apply force perpendicular to axis of wire on samples without cover.
	26	1.3		
	24	1.3		
	22	3.4		
	20	4.0		
	18	4.6		
Durability.	See Note.			AMP Spec 109-27. Manually mate and unmate connector assemblies with printed circuit board for 25 cycles. Mount printed circuit board in fixture.

Figure 1 (cont)

Test Description	Requirement	Procedure
Contact retention.	10.0 pounds minimum.	AMP Spec 109-30. Pull on contact using special cut-away housing.
Mating force.	2.3 pounds maximum initial.	AMP Spec 109-42. Measure force necessary to mate connector assembly with printed circuit board a distance of .125 inch from point of initial contact. Calculate force per contact.
Unmating force.	0.2 pound minimum final.	AMP Spec 109-42. Measure force necessary to unmate connector assembly and printed circuit board. Calculate force per contact.
ENVIRONMENTAL		
Thermal shock.	See Note.	AMP Spec 109-22. Subject mated connectors to 25 cycles between -55 and 85°C.

**NOTE**

*Shall meet visual requirements, show no physical damage, and shall meet requirements of additional tests as specified in the Test Sequence in Figure 2.*

Figure 1 (end)

### 3.6. Product Qualification and Requalification Test Sequence

Test or Examination	Test Group (a)					
	1	2	3	4	5	6
	Test Sequence (b)					
Examination of product	1					
Termination resistance, dry circuit			2,4	3,5		
Termination resistance, specified current		2				
Insulation resistance				2,7		
Dielectric withstanding voltage				1,6		
Temperature rise vs current		1				
Tensile strength, straight and perpendicular (c)						1
Durability			3			
Contact retention					1	
Mating force			1			
Unmating force			5			
Thermal shock				4		

**NOTE**

- (a) See paragraph 4.1.A.
- (b) Numbers indicate sequence in which tests are performed.
- (c) One half of the samples shall be subjected to the straight tensile test and the remaining half to the perpendicular tensile test.

Figure 2

**4. QUALITY ASSURANCE PROVISIONS****4.1. Qualification Testing****A. Sample Selection**

Connector housings and contacts shall be prepared in accordance with applicable Instruction Sheets and shall be selected at random from current production. Test group 1 shall consist of 1 connector of each size, all representative of the entire lot being tested. Test groups 2 through 4 shall consist of 2 connector assemblies per group per wire size. Test group 5 shall consist of 15 contacts chosen randomly from 5 connector assemblies. Test group 6 shall consist of 4 connector assemblies per wire size. Each wire size shall consist of solid, stranded and prefused or overcoated wire; UL style 1007 or 1061 tin plated. Stranded wire shall consist of 7 strands. All wires shall be applied in accordance with AMP Specification 114-1020.

**B. Test Sequence**

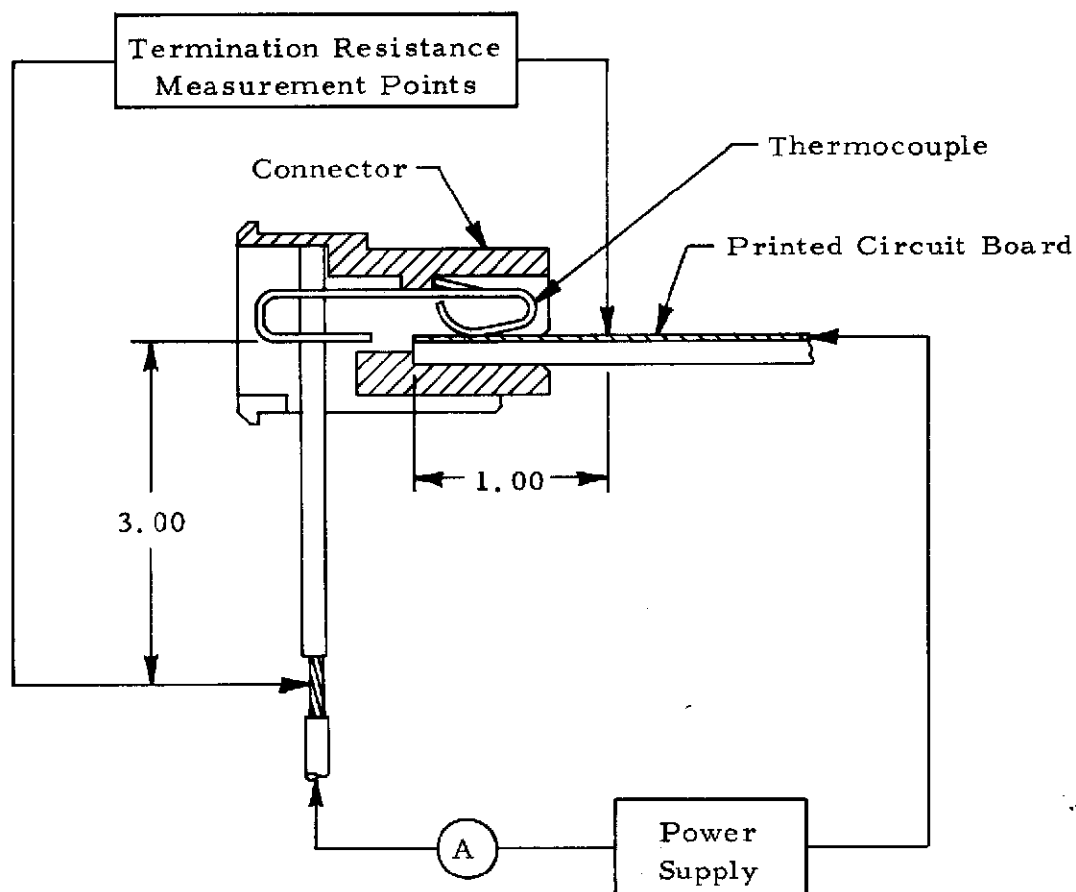
Qualification inspection shall be verified by testing samples as specified in Figure 2.

**4.2. Acceptance**

Acceptance is based on verification that the product meets the requirements of Figure 1. Failures attributed to equipment, test setup or operator deficiencies shall not disqualify the product. If product failure occurs, corrective action shall be taken and samples resubmitted for qualification. Testing to confirm corrective action is required before resubmittal.

**4.3. Quality Conformance Inspection**

The applicable AMP quality inspection plan shall specify the sampling acceptable quality level to be used. Dimensional and functional requirements shall be in accordance with the applicable product drawing and this specification.

**NOTE**

1. A 1 foot minimum length of continuous lead for heat dissipation.
2. Termination resistance equals millivolts divided by test current less resistance of 3 inches of wire and resistance of .90 inch of printed circuit board pad.

Figure 3  
Temperature and Resistance Measurement Points

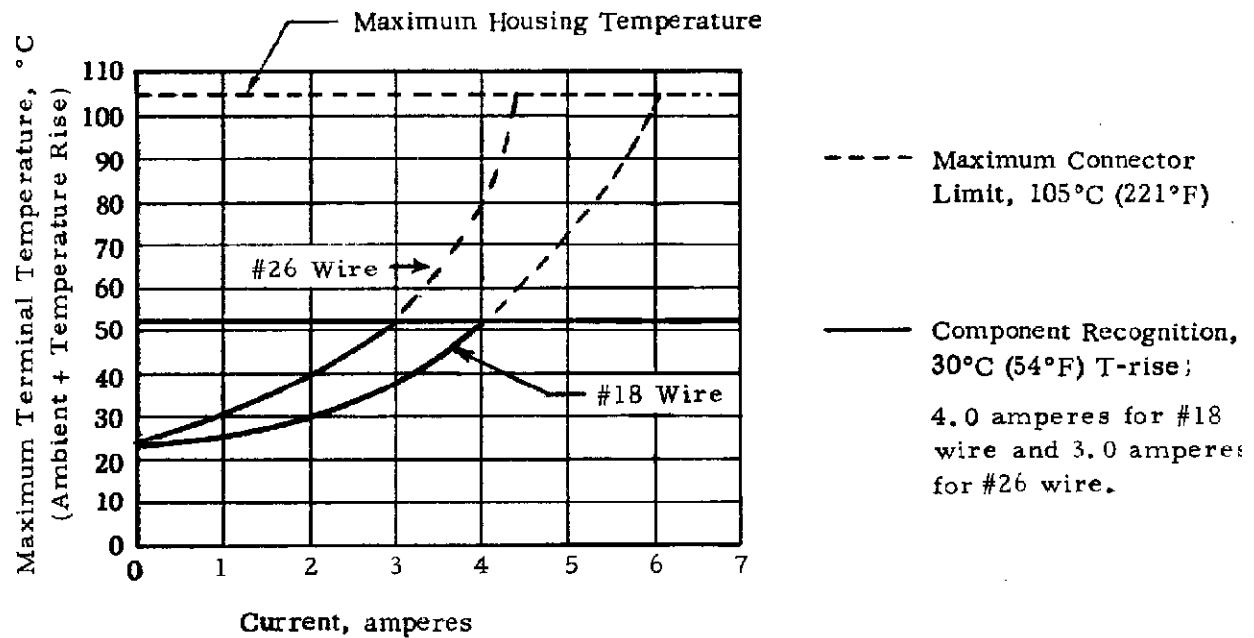
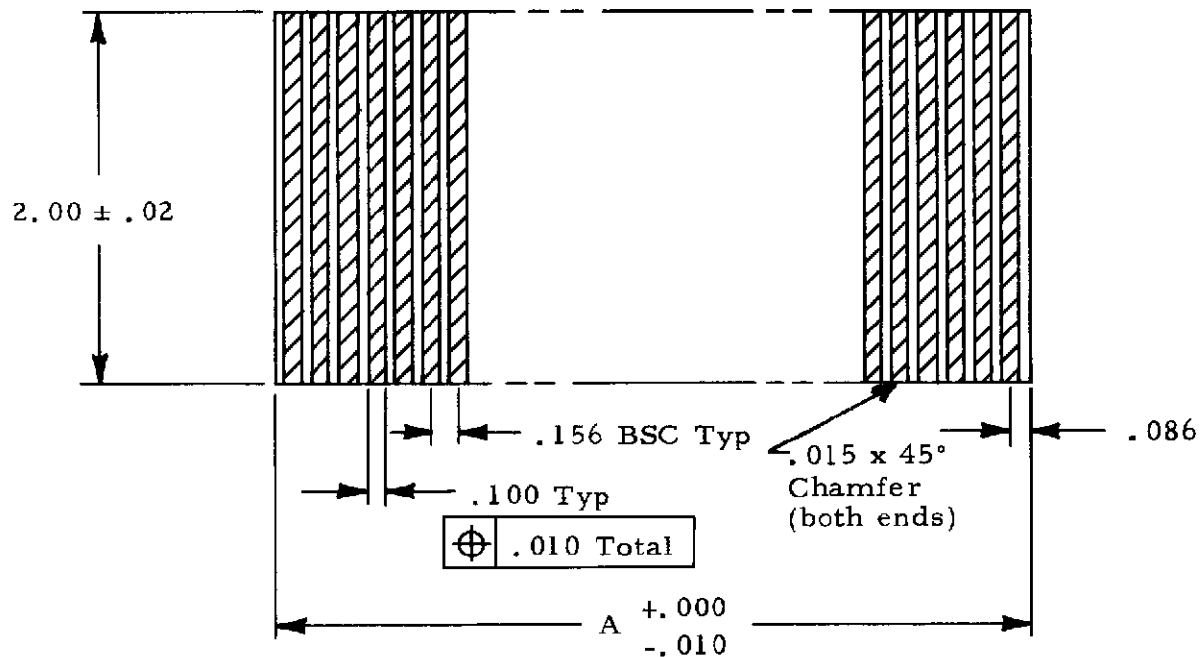


Figure 4  
Terminal Temperature vs Current/Circuit  
24 Circuit Assembly



Number of Circuits	"A" Dimension	"B" Reference (See Note 5)	"C" Reference (See Note 6)	Number of Circuits	"A" Dimension	"B" Reference (See Note 5)	"C" Reference (See Note 6)
2	.328	.344	.469	14	2.200	2.216	2.341
3	.484	.500	.625	15	2.356	2.372	2.497
4	.640	.656	.781	16	2.512	2.528	2.653
5	.796	.812	.937	17	2.668	2.684	2.809
6	.952	.968	1.093	18	2.824	2.840	2.965
7	1.108	1.124	1.249	19	2.980	2.996	3.121
8	1.264	1.280	1.405	20	3.136	3.152	3.277
9	1.420	1.436	1.561	21	3.292	3.308	3.433
10	1.576	1.592	1.717	22	3.448	3.464	3.589
11	1.732	1.748	1.873	23	3.604	3.620	3.745
12	1.888	1.904	2.029	24	3.760	3.776	3.901
13	2.044	2.060	2.185				

**NOTE**

1. Dimensions are in inches.
2. Unless otherwise specified, tolerance is  $\pm .005$ .
3. Number of contacts shall be the same as on the corresponding printed wiring connector.
4. Printed circuit test board, type G10 or equivalent, shall be 3 ounce copper with .000600 minimum tin electrodeposited plating overall thickness  $.062 \pm .008 / -.007$ .
5. Dimension "B" is connector slot width.
6. Dimension "C" is connector overall width.

Figure 5  
Printed Circuit Board